

MOSFET

OptiMOS[™] 6 Power-Transistor, 40 V

Features

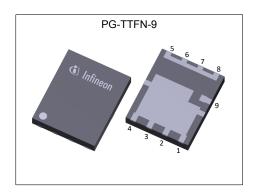
- N-channel, logic level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

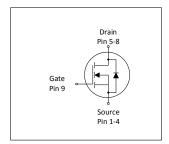
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

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Parameter	Value	Unit					
$V_{ extsf{DS}}$	40	V					
$R_{DS(on),max}$	0.45	mΩ					
I _D	637	A					
Qoss	142	nC					
Q _G	62	nC					











Type / Ordering Code	Package	Marking	Related Links
IQDH45N04LM6CG	PG-TTFN-9	H4504LC	-

OptiMOS[™] 6 Power-Transistor, 40 V



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OptiMOS[™] 6 Power-Transistor, 40 V IQDH45N04LM6CG



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damanastan	Ol	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	637 451 397 60	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =50°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	2548	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	1115	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	333 3.0	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Darameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.45	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Damain Adam	0		Values			N / / T / O III
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	40	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.3	1.6	2.3	V	V _{DS} =V _{GS} , I _D =1449 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =40 V, V _{GS} =0 V, T _j =25 °C V _{DS} =40 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.4 0.5	0.45 0.58	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =4.5 V, I _D =50 A
Gate resistance	R _G	-	0.7	-	Ω	-
Transconductance	g fs	185	370	-	S	V _{DS} ≥2 I _D R _{DS(on)max} , I _D =50 A

Table 5 Dynamic characteristics

Downwater	Symbol	Values			11!4	Nata / Taat Candition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	9000	12000	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	2900	3800	pF	V _{GS} =0 V, V _{DS} =20 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	68	120	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	9	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	6	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	49	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	14	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Cumbal	Values			11::4	Nata / Tank Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	23	-	nC	V_{DD} =20 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	14	-	nC	V_{DD} =20 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	Q _{gd}	-	15	23	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q _{sw}	-	23	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	62	78	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.5	-	V	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total	Qg	-	129	-	nC	V _{DD} =20 V, I _D =50 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	54	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V
Output charge ¹⁾	Qoss	-	142	189	nC	V _{DS} =20 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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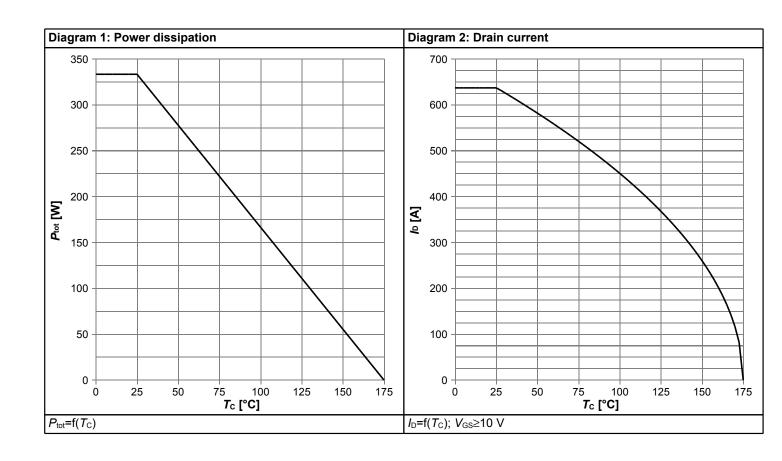


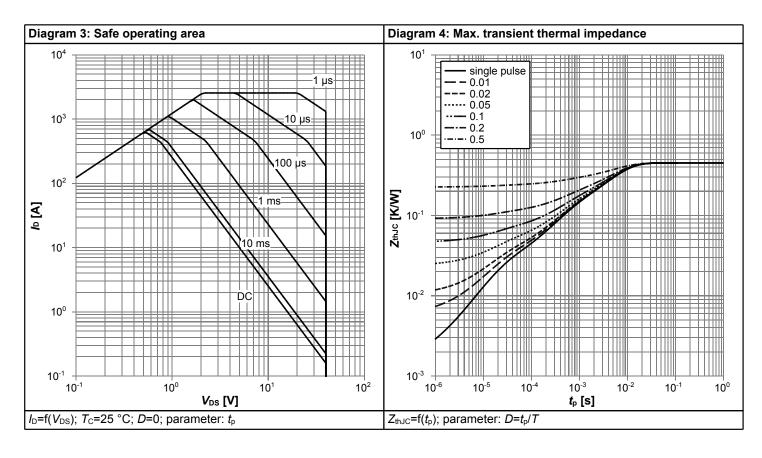
Table 7 Reverse diode

Parameter	Cumbal		Values			Nata / Tank Canadikian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	260	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	2548	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.73	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	54	108	ns	V _R =20 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	63	126	nC	V_R =20 V, I_F =25 A, di_F/dt =100 A/ μ s

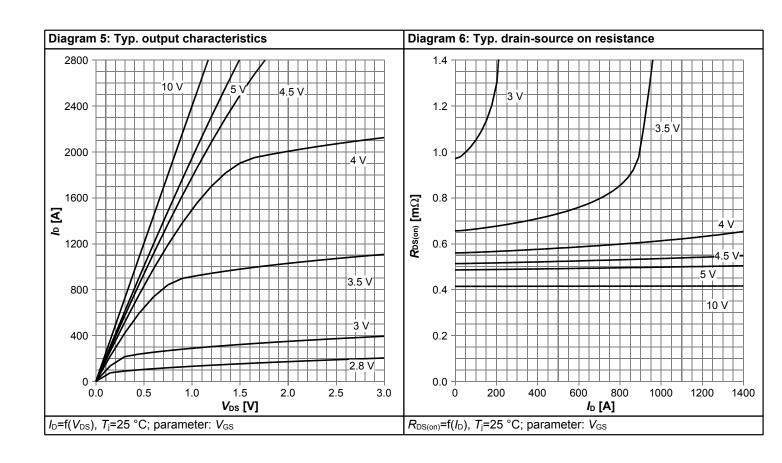


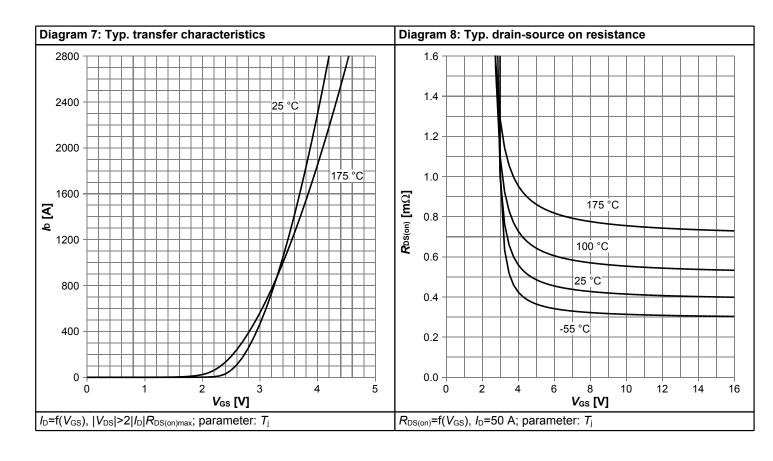
4 Electrical characteristics diagrams



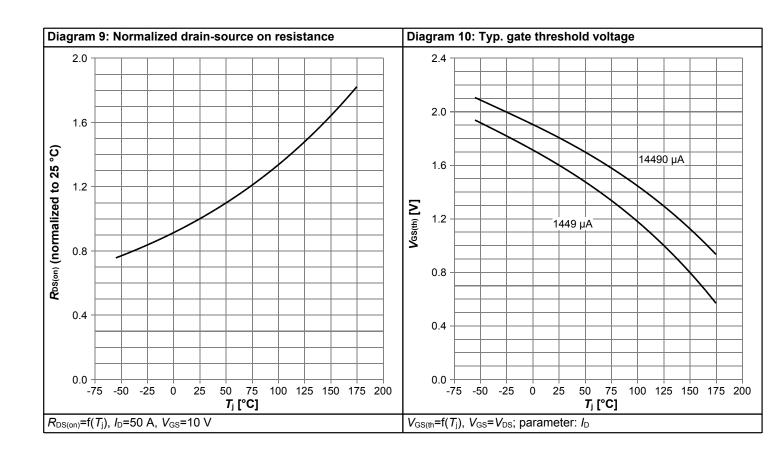


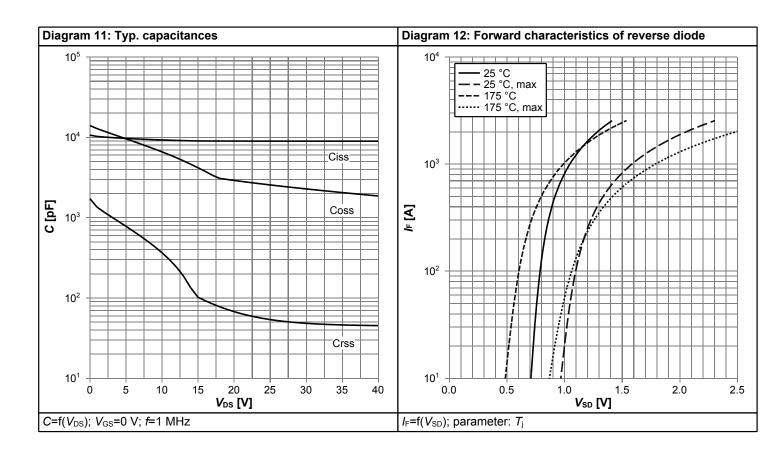




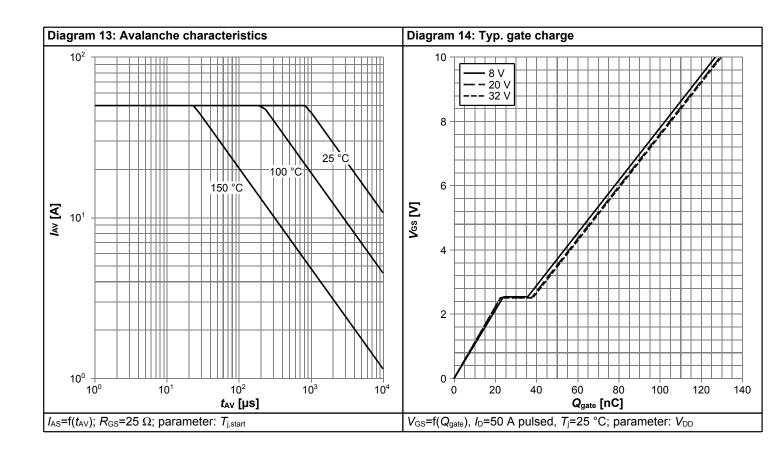


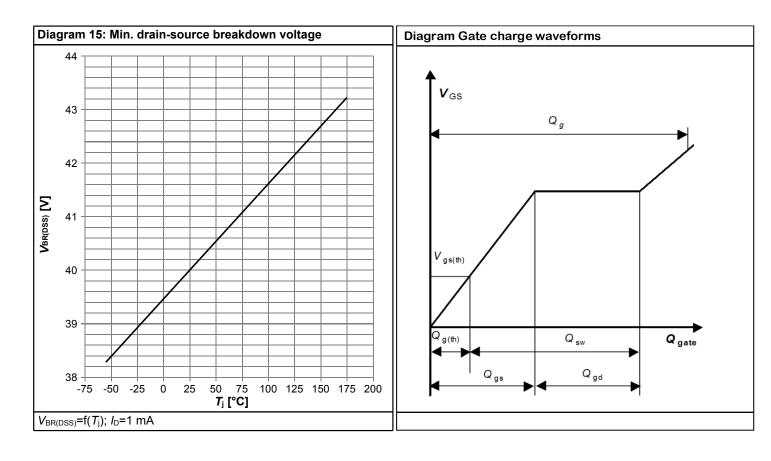














5 Package Outlines

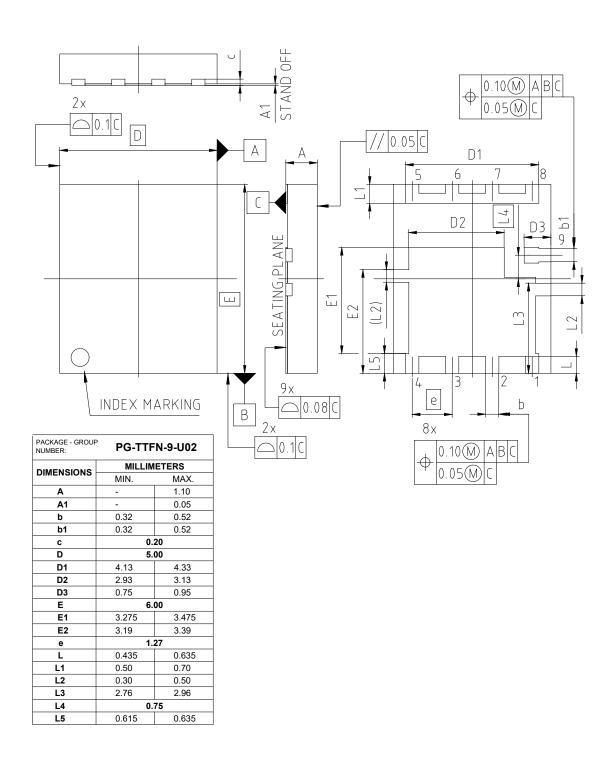


Figure 1 Outline PG-TTFN-9, dimensions in mm

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Revision History

IQDH45N04LM6CG

Revision: 2023-03-29, Rev. 2.1

Previous Revision

	Troviduo Novicion							
Revision	Revision Date Subjects (major changes since last revision)							
2.0	2023-02-28	Release of final version						
2.1	2023-03-29	Update RG, ext for switching times						

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